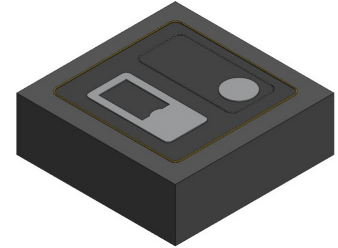


# LA PT22HP1

Standard phototransistor 22 mil

Light Avenue Premium Edition detector series is designed for high performance consumer applications. This device is a silicon NPN phototransistor chip with high radiant sensitivity and ability to drive high currents even under saturation. It is sensitive to visible and near infrared light. Emitter and base is on top of the chip.



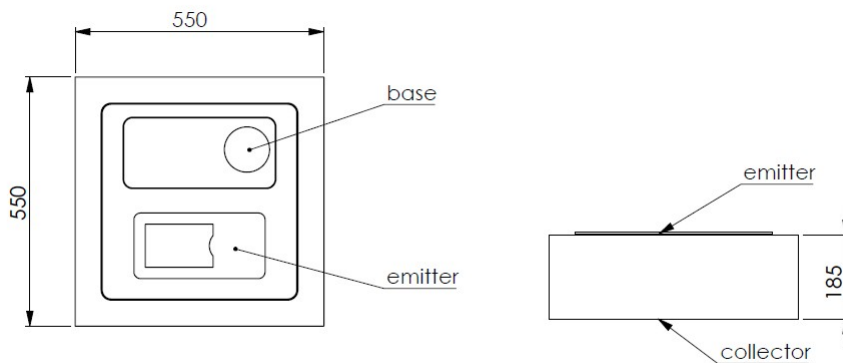
## Features

- High sensitivity silicon NPN phototransistor
- anti reflexion layer for 950 nm
- Small size
- Substrate: 3 - 5 mOhmcm
- Sensitive area: 0.11 mm<sup>2</sup>

## Applications

- Electronic controls
- Optocouplers
- Sensors

## Delineation



## Mechanical characteristics

DESCRIPTION		MINIMUM	TYPICAL <sup>1</sup>	MAXIMUM
Chip length	(µm)	510	550	590
Chip height	(µm)	160	185	210
Frontside contacts, emitter, base		Al		
Backside contact, collector		AuAs		
Die attach		Epoxy bonding		

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## Electro-optical characteristics ( $T_A = 40^\circ\text{C}$ )<sup>2</sup>

PARAMETER	SYMBOL	CONDITION	MIN.	TYP. <sup>1</sup>	MAX.	UNIT
Breakdown voltage	$V_{CE0}$	$I_C = 10\ \mu\text{A}$	35			V
Dark current	$I_{CE0}$	$V_{CE} = 25\ \text{V}$			50	nA
Maximum of sensitivity	$\lambda_p$			870		nm
Spectral bandwidth	$\lambda_{0.1}$			400 - 1070		nm
Saturation voltage	$U_{CESAT}$	$I_C = 2000\ \mu\text{A},$ $I_B = 200\ \mu\text{A}$			400	mV
Linearity	$Q_{IB}$	$I_C = 2\ \text{mA}/100\ \mu\text{A}$			1.4	
Current gain	$H_{FE}$	$I_C = 100\ \mu\text{A},$ $U_{CE} = 5\ \text{V}$		330		
Capacitance	$C_{CE}$	$U_{CE} = 0\ \text{V}, f = 1\ \text{MHz}$		4.5		pF
Leakage current	$I_{CE0}$	$U_{CE} = 15\ \text{V}$		3		nA

## Maximum ratings ( $T_A = 25^\circ\text{C}$ )<sup>3</sup>

PARAMETER	SYMBOL	VALUE	UNIT
Collector current	$I_C$	10	mA
Operating temperature range	$T_{op}$	-40...+125	$^\circ\text{C}$
Storage temperature range	$T_{st}$	-40...+125	$^\circ\text{C}$
Detector junction temperature	$T_j$	125	$^\circ\text{C}$

## Handling and Storage Conditions

Storage time for wafers in sealed condition is not limited by the die itself, but may be limited by the adhesion of the blue foil (storage ambient conditions:  $T_a = 15 \dots 30^\circ\text{C}$ ; relative humidity:  $< 60\%$ , vertical storage). Therefore we ship the dice without any limitation of shelf life. Customer has to make sure that there is no glue from the adhesive foil on the backside either by a die shear test or by visual inspection of the backside before production. The hermetically sealed shipment lot shall be opened under temperature and moisture controlled cleanroom environment only. Customers have to follow the according rules for desposition as the material can be hazardous for humans and the environment. Dice have to be handled ESD sensitive.

## Packing

Chips are placed on a blue foil inside a 6 or 8 inch ring or alternatively on a blue foil (mylar) only. For shipment the wafers of a shipment lot are arranged to stacks. Please use the recycling operators familiar to you. If required you can ask for our help. Please get in touch with your nearest sales office. By agreement we will take packing material back, if sorted. Transport costs of any kind must be paid by customers. For packing material that is returned to us unsorted or which we are not obliged to accept, any costs incurred will be invoiced to you.

## Design Objectives

The chip design was developed and released based on the producer's standard assembly procedures and packaging. Bond strength properties are in accordance to MIL-STD-750D, method 2037. Whether the chip fits to the customer's products with its according die and wire bond procedures and packaging must be evaluated by the customer himself. If workability problems arise after this release a mutually conducted problem solving procedure has to be set up, if the chips are suspected of contributing to the problems. The chips are produced with best effort, but on chip level a subset of the chip characteristics can be determined only. Performance of the chip in the customer's products can only be determined by the customer himself.

## Returns and Complaints

For complaints and returns of material a RMA-number is necessary. Samples for analysis purposes can be send to us without credit.

## Shipping Conditions

If not otherwise arranged, the "General Terms of Business of Chips 4 Light GmbH" apply for any shipment. If this document is not familiar to you, please request it at our nearest sales office.

## Disclaimer

### Attention please!

- **Components used in life-support devices or systems must be expressly authorized for such purpose!**

Critical components<sup>4</sup> may only be used in life-support devices<sup>5</sup> or systems with the express written approval by us.

- All products, product specifications and data to improve reliability, function, design or otherwise are subject to change without notice .
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- The information describes the type of component and shall not be considered as assured characteristics. Due to technical requirements components may contain dangerous substances. For information on the types in question please contact our Sales Organization.
- Lead free product - RoHS compliant.
- The quality level of the final visual inspection shall comply to an AQL of 1.0 (according to MIL-STD-105E, level II), if the customer performs an incoming visual inspection of a shipment.

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- All chips are checked according to the producer's specification of the visual inspection. If this document is not familiar to you, please request it at our nearest sales office.

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<sup>1</sup>Due to the special conditions of the manufacturing processes of the device, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

<sup>2</sup>Measurements are done with an accuracy of  $\pm 15\%$ . Correlation to customer's equipment and products is required.

<sup>3</sup>Maximum ratings are package dependent and may differ between packages.

<sup>4</sup>A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

<sup>5</sup>Life support devices or systems are intended(a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health and the life of the user may be endangered..